

Vishay Siliconix

Single P-Channel 20 V (D-S) MOSFET With Schottky Diode

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
- 20	0.048 at V _{GS} = - 4.5 V	- 6.3			
	0.068 at V _{GS} = - 2.5 V	- 5.3			
	0.090 at V _{GS} = - 1.8 V	- 4.6			

SCHOTTKY PRODUCT SUMMARY

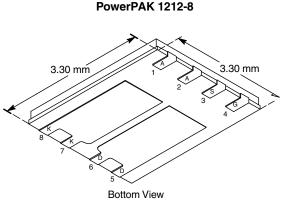
V _{KA} (V)	V _f (V) Diode Forward Voltage	I _F (A)
20	0.48 V at 0.5 A	1

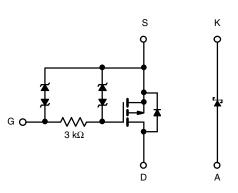
FEATURES

- TrenchFET[®] Power MOSFETS: 1.8 V Rated
- ESD Protected: 4500 V
- Ultra-Low Thermal Resistance, PowerPAK[®]
 Package with Low 1.07 mm Profile
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

• Charger Switching





P-Channel MOSFET

Ordering Information:

Si7703EDN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage (MOSFET and Schottky)		V _{DS}	- 20		
Reverse Voltage (Schottky)		V _{KA}	20		V
Gate-Source Voltage (MOSFET)	V _{GS}	± 12	± 12		
Continuous Drain Current /T 150 °C) (MOSEE	$T_A = 25 °C$	I _D	- 6.3	- 4.3	
Continuous Drain Current ($T_J = 150 \ ^\circ$ C) (MOSFET	T _A = 85 °C		- 4.5	- 3.1	
Pulsed Drain Current (MOSFET)		I _{DM}	- 20		А
Continuous Source Current (MOSFET Diode Conduction) ^a		ا _S	- 2.3	- 1.1	А
Average Foward Current (Schottky)		١ _F	1		
Pulsed Foward Current (Schottky)		I _{FM}	7		
	T _A = 25 °C		2.8	1.3	W
Maximum Power Dissipation (MOSFET) ^a	T _A = 85 °C	Pn	1.5	0.7	
	T _A = 25 °C	· D	2	1.1	vv
Maximum Power Dissipation (Schottky) ^a	T _A = 85 °C		1	0.6	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations ^{b,c}			260		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.





Vishay Siliconix



THERMAL RESISTANCE RATINGS							
Parameter		Device	Symbol	Typical	Maximum	Unit	
Junction-to-Ambient ^a	t < 10 o	MOSFET	- R _{thJA}	35	44	°C/W	
	t ≤ 10 s	Schottky		51	64		
	Ctoody Ctoto	MOSFET		75	94		
	Steady State	Schottky		91	115		
Junction-to-Case (Drain)	Ctoody Ctoto	MOSFET	R _{thJC}	4	5		
	Steady State	Schottky		10	12		

Notes

a. Surface Mounted on 1" x 1" FR4 board.

Parameter	Symbol	Test Conditions	Тур.	Max.	Unit			
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -800 \ \mu A$	- 0.45		- 1	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$		± 1.5		μA		
		$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	mA		
Zaus Osta Valtana Dusia Orumant		V _{DS} = - 20 V, V _{GS} = 0 V	V _{DS} = - 20 V, V _{GS} = 0 V		- 1			
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5	- μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	- 20			А		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 4.5 V, I _D = - 6.3 A		0.041	0.048	Ω		
		V _{GS} = - 2.5 V, I _D = - 5.3 A		0.057	0.068			
		V _{GS} = - 1.8 V, I _D = - 1 A		0.072	0.090	1		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 6.3 A		14		S		
Diode Forward Voltage ^a	V _{SD}	I _S = - 2.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V		
Dynamic ^b				•				
Total Gate Charge	Qg			12	18			
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 6.3 A		2.5		nC		
Gate-Drain Charge	Q _{gd}			2.9				
Turn-On Delay Time	t _{d(on)}			2.5	4			
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		4	6]		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong$ - 1 A, V_{GEN} = - 4.5 V, R_G = 6 Ω		15	23	vs		
Fall Time	t _f			12	18	1		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Max.	Unit			
Forward Voltage Drop	V _F	I _F = 0.5 A		0.42	0.48	v	
		I _F = 0.5 A, T _J = 125 °C		0.33	0.4		
Maximum Reverse Leakage Current	I _{rm}	V _r = 20 V		0.002	0.100		
		$V_{r} = 20 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$		0.10	1	mA	
		V _r = 20 V, T _J = 125 °C		1.5	10	1	
Junction Capacitance	CT	V _r = 10 V		31		pF	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

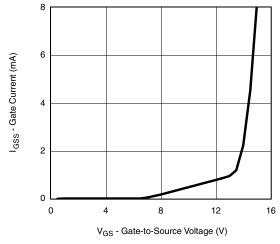
For technical questions, contact: pmostechsupport@vishay.com



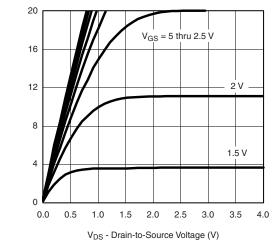
ID - Drain Current (A)

Si7703EDN Vishay Siliconix

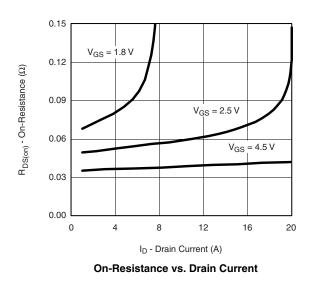
MOSFET TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

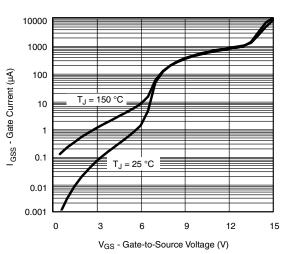


Gate-Current vs. Gate-Source Voltage

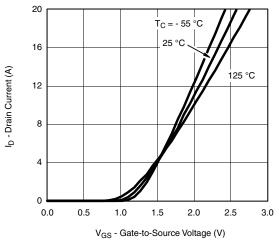




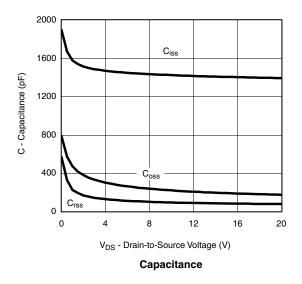




Gate Current vs. Gate-Source Voltage



Transfer Characteristics



Document Number: 71429 S13-0297-Rev. D, 11-Feb-13

For technical questions, contact: pmostechsupport@vishay.com

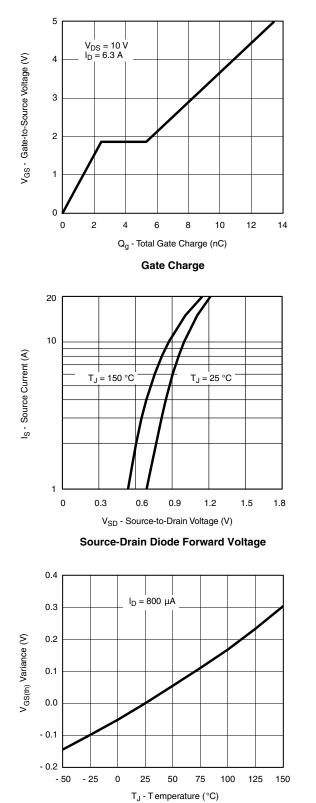
www.vishay.com 3

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

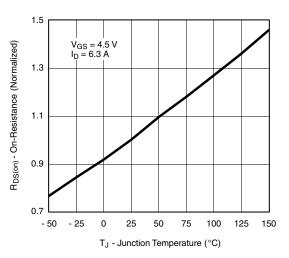


Vishay Siliconix

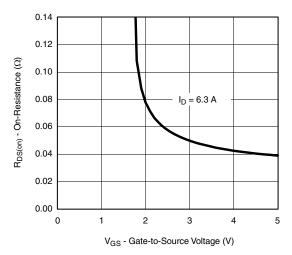
MOSFET TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



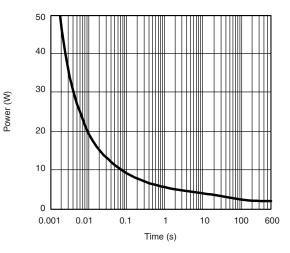
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

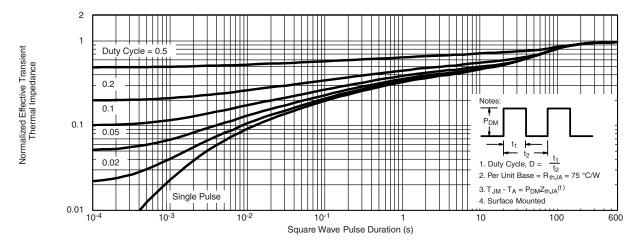
For technical questions, contact: pmostechsupport@vishay.com

Document Number: 71429 S13-0297-Rev. D, 11-Feb-13

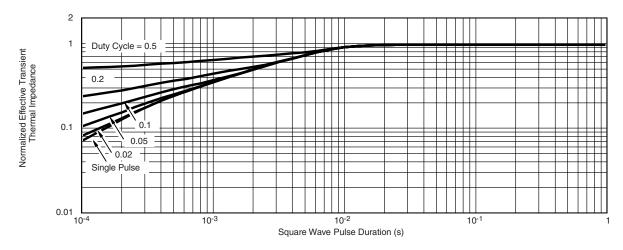
This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



MOSFET TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

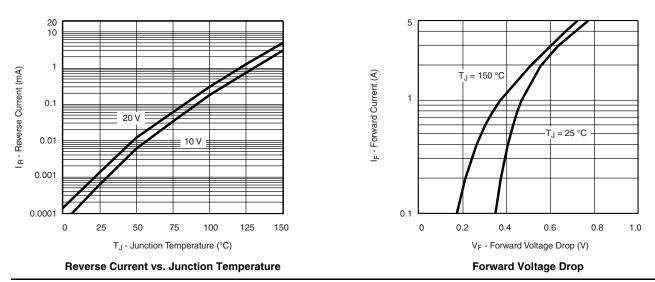


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

SCHOTTKY TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

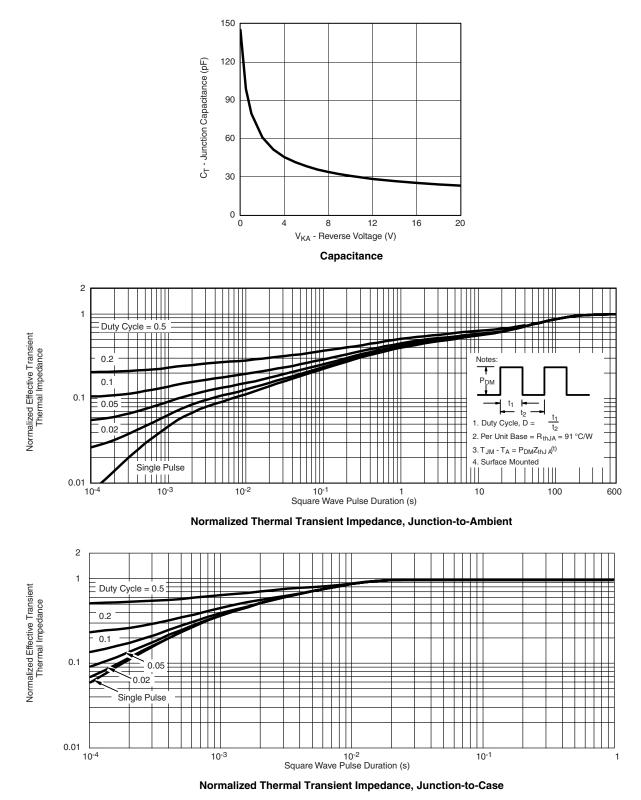


Document Number: 71429 www.vishay.com For technical questions, contact: pmostechsupport@vishay.com S13-0297-Rev. D, 11-Feb-13 5 This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Siliconix



SCHOTTKY TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71429.

www.vishay.com 6

For technical questions, contact: pmostechsupport@vishay.com

Document Number: 71429 S13-0297-Rev. D, 11-Feb-13

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.